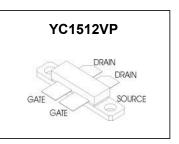
YC1512VP LDMOS TRANSISTOR

Document Number: YC1512VP Preliminary Datasheet V1.0

120W, 50V High Power RF LDMOS FETs

Description

The YC1512VP is a 120-watt, highly rugged, unmatched LDMOS FET, designed for wide-band commercial and industrial applications with frequencies HF to 1.5 GHz. It is featured for high power and high ruggedness, suitable for Industrial, Scientific and Medical application, as well as FM radio, VHF TV and Aerospace applications.



• Typical Performance (On Yingtron narrow band fixture with device soldered): $V_{DD} = 50$ Volts, $I_{DQ} = 100$ mA, CW.

Frequency	Gp (dB)	P _{out} (W)	η _@P out (%)
915 MHz	23	120	60

Features

- High Efficiency and Linear Gain Operations
- Integrated ESD Protection
- Excellent thermal stability, low HCI drift

Suitable Applications

- 2-30MHz (HF or Short wave communication)
- 30-88MHz (Ground communication)
- 54-88MHz (TV VHF I)
- 88-108MHz (FM)
- 118 -140MHz (Avionics)
- 1200-1400MHz(L band)

- Large Positive and Negative Gate/Source Voltage Range for Improved Class C Operation
- Pb-free, RoHS-compliant
- 136-174MHz (Commercial ground communication)
- 160-230MHz (TV VHF III)
- 30-512MHz (Jammer, Ground/Air communication)
- 470-860MHz (TV UHF)
- 100kHz 1000MHz (ISM, instrumentation)
- 960-1215MHz(Avionics)

Table 1. Maximum Ratings

Rating	Symbol	Value	Unit
DrainSource Voltage	V _{DSS}	+125	Vdc
GateSource Voltage	V _{gs}	-10 to +10	Vdc
Operating Voltage	V _{DD}	+55	Vdc
Storage Temperature Range	Tstg	-65 to +150	°C
Case Operating Temperature	T _c	+150	°C
Operating Junction Temperature	TJ	+225	°C

Table 2. Thermal Characteristics

Characteristic	Symbol	Value	Unit	
Thermal Resistance, Junction to Case	Rejc	0.7	°C/W	
T _C = 85°C, Pout=120W CW,	Kejc	0.7	-0/11	

Table 3. ESD Protection Characteristics

Test Methodology	Class		
Human Body Model (per JESD22A114)	Class 2		

YC1512VP LDMOS TRANSISTOR

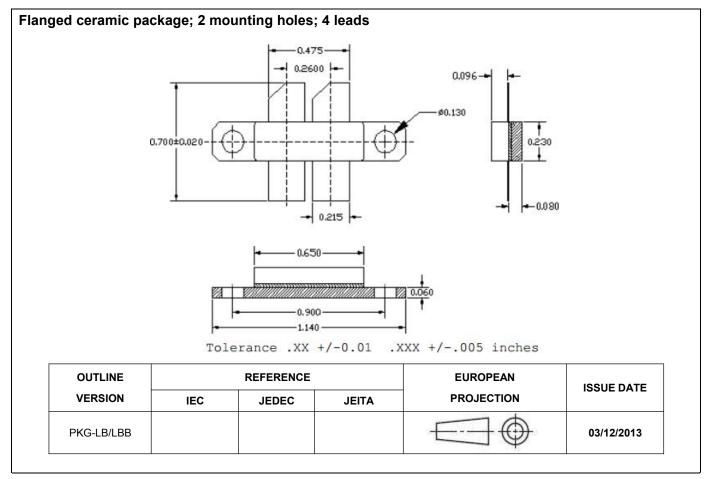
Table 4. Electrical Characteristics (TA = 25 $^{\circ}$ C unless otherwise noted)

Characteristic		Min	Тур	Max	Unit
DC Characteristics					
Drain-Source Voltage	V _{(BR)DSS}		100		
V _{GS} =0, I _{DS} =1.0Ma			122		V
Zero Gate Voltage Drain Leakage Current	I _{DSS}			1	
$(V_{DS} = 50V, V_{GS} = 0 V)$					μΑ
Gate—Source Leakage Current				4	
$(V_{GS} = 10 \text{ V}, V_{DS} = 0 \text{ V})$	I _{GSS}			1	μΑ
Gate Threshold Voltage	Maria	/ _{GS} (th)	2.65		v
$(V_{DS} = 50V, I_{D} = 600 \mu A)$	V _{GS} (th)				
Gate Quiescent Voltage	V _{GS(Q)}		3.57		v
(V _{DD} = 50 V, I_D = 400 mA, Measured in Functional Test)					v
Drain source on state resistance	Dda(an)		448		mΩ
(V_{DS} = 0.1V, V_{GS} = 10 V) Each section side of device measured	Rds(on)		440		
Common Source Input Capacitance	C _{ISS}		55.5		pF
(V_{GS} = 0V, V_{DS} =50 V, f = 1 MHz) Each section side of device measured					
Common Source Output Capacitance	C _{oss}		22.6		pF
(V_{GS} = 0V, V_{DS} =50 V, f = 1 MHz) Each section side of device measured					
Common Source Feedback Capacitance	C _{RSS}		0.57		pF
(V_{GS} = 0V, V_{DS} =50 V, f = 1 MHz) Each section side of device measured					

Functional Tests (In Demo Test Fixture, 50 ohm system) V_{DD} = 50 Vdc, I_{DQ} = 400mA, f = 915 MHz, CW Signal Measurements, Pin=22.5dBm

Power Gain@Pout	Gp	 23	 dB
Output Power	Pout	120	W
Drain Efficiency@Pout	η_{D}	 60	 %
Input Return Loss	IRL	 -7	 dB
Ruggedness at all phase angle	VSWR	10:1	

Package Outline



Revision history

Date	Revision	Datasheet Status
2017/9/15	Rev 1.0	Preliminary Datasheet Creation

Disclaimers

Specifications are subject to change without notice. Yingtron believes the information contained within this data sheet to be accurate and reliable. However, no responsibility is assumed by Yingtron for any infringement of patents or other rights of third parties which may result from its use. No license is granted by implication or otherwise under any patent or patent rights of Yingtron. Yingtron makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose. "Typical" parameters are the average values expected by Yingtron in large quantities and are provided for information purposes only. These values can and do vary in different applications and actual performance can vary over time. All operating parameters should be validated by customer's technical experts for each application. Yingtron products are not designed, intended or authorized for use as components in applications intended for surgical implant into the body or to support or sustain life, in applications in which the failure of the Yingtron product could result in personal injury or death or in applications for planning, construction, maintenance or direct operation of a nuclear facility. For any concerns or questions related to terms or conditions, pls check with us.

Copyright by Yingtron Microwave Electronics Co., Ltd.